

METHODS FOR PLANARIZATION OF METAL-CONTAINING SURFACES  
USING HALOGENS AND HALIDE SALTS

5

Abstract of the Disclosure

A planarization method includes providing a metal-containing surface (preferably, a Group VIII metal-containing surface, and more preferably a platinum-containing surface) and positioning it for contact with a polishing surface in the presence of a planarization composition that includes a halogen and a halide salt.

10

"Express Mail" mailing label number: EV 201890272 US

Date of Deposit: February 3, 2004

I hereby certify that the Transmittal Letter and the paper(s) and/or fee(s), as described hereinabove, are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 C.F.R. 1.10 on the date indicated above and is addressed to the Commissioner for Patents, Mail Stop Patent Application, P.O. Box 1450, Alexandria, VA 22313-1450.

*Sara E. Olson*  
Name: Sara E. Olson